Mechanics, readout and cooling systems of the **Mu3e** experiment

Frank Meier Paul Scherrer Institute

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## Prelude

## What is Mu3e about?



Mu3e is an experiment to search for

$$\mu^+ 
ightarrow e^+ e^- e^+$$

A very rare decay.

We're in an unusual regime, hence allow for some physics background.



#### Introduction to Mu3e

 $\mu \rightarrow \textit{eee}$  in the standard model.



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$$\label{eq:SM: large} \begin{split} \text{SM:} &< 1 \times 10^{-54} \\ \text{The suppression comes from the} \\ \text{neutrino masses.} \end{split}$$

Current best limit:  $< 1 \times 10^{-12}$  (SINDRUM 1988)

Alternative models predict BR within reach of Mu3e ( $<1\times10^{-16}).$ 





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 $\sum_{\substack{i \neq j \\ p_i = 0}} p_i = 0$  $m_{inv} = m_{\mu}$  $t_i = t_j \quad \forall i, j$ 





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Radiative decay SM:  $3.4\times10^{-5}$ 

e

v

 $\sum_{i=1}^{n} p_i \neq 0$  $m_{inv} < m_{\mu}$  $t_i = t_j$ common vertex







Introduction to Mu3e – hypothetical signal responses



## Part I

## Search for $\mu \rightarrow$ eee with pixels.



- ▶ Low momentum electrons,  $p_e \leq 53 \text{ MeV}$
- $\blacktriangleright$   $\mu$  decay whenever they will.
- No trigger.



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- $\mu$  decay whenever they will.  $\Rightarrow$  **Always on.**
- No trigger.  $\Rightarrow$  Capture all hits.



Phase-I configuration:







Phase-I configuration:



- ▶ High rate: 10<sup>8</sup> muon stops on target per second
- ► Time resolution (pixels): 20 ns
- Vertex resolution: about 200 μm
- Momentum resolution: about 0.5 MeV
- All inside a cryogenic 1 T magnet, warm bore I.D. 1 m



#### Mu3e detector concepts – Layers 1/2

Modules layer 2 design (1 is similar, one facet less)



Inner modules have ladders of 6 chips each. Observe: No V-folds here.

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Modules layer 2 design (1 is similar, one facet less)





Exploded view of same part.



Cut in the  $r - \phi$  plane.

Yellow: **active** pixel matrix Red: **periphery**, non-sensitive but has material and is a source of heat.

The gap (light blue) will be used for the **cooling** (see later).



To briefly put that into perspective:





Shown: One one module per layer inserted.









Radiation length:  $\approx 0.1\% x/X_0$ 



## Part II

## Reading out data with aluminium HDI.



Our HDI stack:



Aluminium thickness: 12 µm. Why? Reduce material.

Test setup with 24 cm long HDI (conservative, detector will use 18 cm):



Board on the left is our standard single chip board. HDI acts as an "expandion cord".



#### A closer look to the chip:



Connections are made using *single point tape automated bonding* (SpTAB), bonding the aluminium trace directly to the chip pad (no wire).







<sup>90</sup>Sr source



Eye diagram at 1.25 GHz

It works well! BER  $\leq 1.5 \times 10^{-15}$  (measurement ongoing as we speak)

## Part III

# Cooling of a pixel detector with gaseous helium.



Cooling needs:

- $\blacktriangleright~2844~chips$  à 20  $\times~20\,mm^2$  active area  $\Rightarrow~1.14\,m^2$  instrumented
- ▶ 250 mW/cm<sup>2</sup> heat dissipation  $\Rightarrow$  about 3 kW
- $\blacktriangleright\,$  Upper temperature governed by glue  $\Rightarrow <\!60\,^\circ\text{C}$
- Temperature gradient along ladders acceptable
- Stability over time is crucial, not absolute temperature



Why helium at ambient pressure?

- $\blacktriangleright\,$  Radiation length  $\approx 17\times\,$  larger than air
- ► Large speed of sound: 980 m/s
- Spec. heat capacity 5.2 kJ/(kg K) (air: 1 kJ/(kg K))
- Inert
- Affordable



The low-mass paradigm doesn't allow for traditional liquid cooling. Hence we switch to Helium, the lowest mass gas.











Example CFD simulation result for vertex detector.

 $P/A = 400 \text{ mW/cm}^2$ , unequally distributed among periphery and pixel matrix

Chip size  $20\times23\,\text{mm}^2$ 



Simulation is nice. Measuring something in the lab is nicer.





We started with tape heater ladders...

Aluminium-polyimide laminate, stainless steel plates ( $d = 50 \,\mu$ m). All dimensions match current detector design.





 $\dots$  assemble them to a L1/2 mockup...

Again everything matches specs, especially mechanical structure is final. Electrical connections using Samtec ZA8H interposers.





...integrate it into a test stand...

Low-mass thermocouples added to mockup structure.





... that offers all the diagnostics needed.

This setup can be operated with air and helium. NB: One bottle of 50 Lhelium at 200 bar offers 12 min of measuring time with 2 g/s mass flow.



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Heat maps in simulation suggested the formation of a vortex.

Do we see it in the lab?

(c) CFD - optimised inflow geometry.





Heat maps in simulation suggested the formation of a vortex.

Yes. Views of simulation match view of IR camera.



(c) CFD - optimised inflow geometry.



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Temperature

Simulation of full detector, central part shown.

Observe the temperature at low radii where the SciFi will be.

No significant heat influx to SciFi.



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Simplified conceptual sketch



25.9.19, F. Meier

#### Conclusions

- Low momentum tracking with thin pixels is possible, but poses unique challenges in detector design.
- > You have to leave the **comfort zone** of past experience in detector construction.
- ▶ Thin aluminium HDI work, 1.25 Gbit/s demonstrated.
- Gaseous helium cooling demonstrated in simulation and in the lab.
- Next steps: MuPix10 (see talk by A. Schöning), helium plant



# **ENCORE**



Let's focus on the pixels. Monte-Carlo studies led to the following geometry:



Identical copies of layers 3/4 will extend the detector in z to extend coverage for recoiling tracks.





Ok, we got the geometry. But what about the material budget of the pixel layers?

Let's put this into perspective:

Experiment	Ref.	$x/X_0$ per layer [%]
ATLAS IBL	[?]	1.9
CMS Phase I	[?]	1.1
ALICE upgrade	[?]	0.3
STAR	[?]	0.4
Belle-II IBL	[?]	0.2
Mu3e		0.1



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